



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No.:

10/079,864

Filed:

February 21, 2002

Inventor:

Masahiro Yonemochi

For:

Insert-Moldable Heat Spreader,

Semiconductor Device Using Same, and

Method For Manufacturing Such

Semiconductor Device

Examiner:

William D. Coleman

Art Unit:

2811

Atty. Doc. No.: 039-02

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service First Class mail postage prepaid in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria VA

22313-1450, on August 10, 2004

n F. McNulty, Reg No. 23,02 Dated: August 10, 2004

COVER LETTER WITH CERTIFICATE OF MAILING

Mail Stop PGPUB Drawings Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Enclosed herewith are the following:

- (1) Cover letter with Certificate of Mailing;
- (2) Formal Drawings reflecting corrections (5 pages);
- (3) Paul & Paul Postcard to be returned by the PTO.

THE COMMISSIONER IS HEREBY AUTHORIZED TO CHARGE ANY ADDITIONAL FEES ASSOCIATED WITH THIS COMMUNICATION, OR CREDIT ANY OVERPAYMENT, TO PAUL & PAUL DEPOSIT ACCOUNT NO. 16-0750, ORDER NO. 2489.

Respectfully submitt

John F. McNulty Reg. No. 23,028 Paul & Paul

2900 Two Thousand Market Street

Philadelphia, PA 19103

(215) 568-4900